

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|--|---|------------------|---------|------------------|
| L1 | 118 | (hysol near1 ("4323" "4451" "4450")) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:11 |
| L2 | 0 | 1 same (shringk\$4 expand\$4) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 15:59 |
| L3 | 10 | 1 and (shringk\$4 expand\$4) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:18 |
| L4 | 20 | 1 with cure\$3 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:04 |
| L5 | 0 | 1 and ((cure cured curing) with (shringk\$4 expand\$4)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:09 |
| L6 | 518 | epox\$3 with ((cure cured curing) with (shringk\$4 expand\$4)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:26 |
| L7 | 504 | (epoxy epoxies) with ((cure cured curing) with (shringk\$4 expand\$4)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:26 |
| L8 | 340 | ((epoxy epoxies) near1 resin) with ((cure cured curing) with (shringk\$4 expand\$4)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:12 |

EAST Search History

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| L9 | 0 | 7 and ((hysol dexter) with ("4323" "4451" "4450")) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:11 |
| L10 | 175 | 8 and adhesive | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:14 |
| L11 | 13 | 10 and (semiconductor chip) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:14 |
| L12 | 20 | 1 and (shrink\$4 expand\$4) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:18 |
| L13 | 0 | (epoxy epoxies) with ((cure cured curing) with shrink\$4) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:27 |
| L14 | 1 | (epoxy epoxies) same (cure cured curing) same shrink\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/05/11 16:27 |